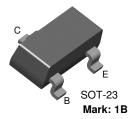


## **MMBT2222**

### **NPN General Purpose Amplifier**

• Sourced from process 19.



## **Absolute Maximum Ratings\*** $T_a$ =25°C unless otherwise noted

Symbol	Parameter	Ratings	Units	
V <sub>CEO</sub>	Collector-Emitter Voltage	30	V	
V <sub>CBO</sub>	Collector-Base Voltage	60	V	
V <sub>EBO</sub>	Emitter-Base Voltage	5.0	V	
I <sub>C</sub>	Collector Current - Continuous	0.6	Α	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range	-55 ~ 150	°C	

<sup>\*</sup> This ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

These rating are based on a maximum junction temperature of 150 degrees C.
 These are steady limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

### Electrical Characteristics T<sub>a</sub>=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Max.	Units
Off Charac	cteristics				
V <sub>(BR)CEO</sub>	Collector-Emitter Breakdown Voltage *	$I_C = 10 \text{mA}, I_B = 0$	30		V
V <sub>(BR)CBO</sub>	Collector-Base Breakdown Voltage	$I_{C} = 10\mu A, I_{E} = 0$	60		V
V <sub>(BR)EBO</sub>	Emitter-Base Breakdown Voltage	$I_E = 10\mu A, I_C = 0$	5.0		V
I <sub>CBO</sub>	Collector Cutoff Current	$V_{CB} = 50V, I_E = 0$ $V_{CB} = 50V, I_E = 0, T_a = 125^{\circ}C$		10 10	μ <b>Α</b> μ <b>Α</b>
I <sub>EBO</sub>	Emitter Cutoff Current	V <sub>EB</sub> = 3.0V, I <sub>C</sub> = 0		10	nA
On Charac	cteristics		•		
h <sub>FE</sub>	DC Current Gain	$\begin{split} &I_{C} = 0.1 \text{mA, V}_{CE} = 10 \text{V} \\ &I_{C} = 1.0 \text{mA, V}_{CE} = 10 \text{V} \\ &I_{C} = 10 \text{mA, V}_{CE} = 10 \text{V} \\ &I_{C} = 150 \text{mA, V}_{CE} = 10 \text{V} \\ &I_{C} = 150 \text{mA, V}_{CE} = 1.0 \text{V} \\ &I_{C} = 500 \text{mA, V}_{CE} = 10 \text{V} \\ \end{split}$	35 50 75 100 50 30	300	
V <sub>CE(sat)</sub>	Collector-Emitter Saturation Voltage *	I <sub>C</sub> = 150mA, I <sub>B</sub> = 15V I <sub>C</sub> = 500mA, I <sub>B</sub> = 50V		0.4 1.6	V
V <sub>BE(sat)</sub>	Base-Emitter Saturation Voltage	I <sub>C</sub> = 150mA, I <sub>B</sub> = 15V I <sub>C</sub> = 500mA, I <sub>B</sub> = 50V		1.3 2.6	V

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Symbol	Parameter	Test Condition	Min.	Max.	Units
Small Sign	nal Characteristics	·			
f <sub>T</sub>	Curent Gain Bandwidth Product	I <sub>C</sub> = 20mA, V <sub>CE</sub> = 20V, f = 100MHz	250		
C <sub>obo</sub>	Output Capacitance	$V_{CB} = 10V, I_{E} = 0, f = 1MHz$		8.0	pF
C <sub>ibo</sub>	Input Capacitance	$V_{EB} = 0.5V$ , $I_{C} = 0$ , $f = 1MHz$		30	pF
Switching	Characteristics				
t <sub>d</sub>	Delay Time	$V_{CC} = 30V, V_{BE(OFF)} = 0.5V,$		10	ns
t <sub>r</sub>	Rise Time	I <sub>C</sub> = 150mA, I <sub>B1</sub> = 15mA		25	ns
t <sub>s</sub>	Storage Time	V <sub>CC</sub> = 30V, I <sub>C</sub> = 150mA,		225	ns
t <sub>f</sub>	Fall Time	$I_{B1} = I_{B2} = 15mA$		60	ns

<sup>\*</sup> Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2.0%

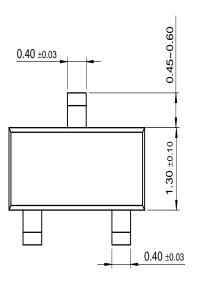
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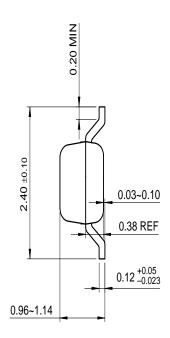
Symbol	Parameter	Max.	Units
P <sub>D</sub>	Total Device Dissipation	350	mW
	Derate above 25°C	2.8	mW/°C
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	357	°C/W

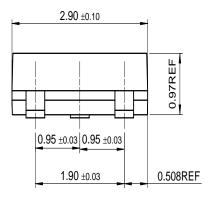
<sup>\*</sup> Device mounted on FR-4PCB 1.6" × 1.6" × 0.06".

# **Package Dimensions**

# SOT-23







Dimensions in Millimeters

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### PRODUCT STATUS DEFINITIONS

#### **Definition of Terms**

Datasheet Identification	Product Status	Definition
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